

FABIO GUALANDRIS
Executive Vice President
Head of Back-End Manufacturing & Technology
STMicroelectronics

Fabio Gualandris is Executive Vice President, Head of ST's Back-End Manufacturing & Technology organization and has held this position since January 2016.

Gualandris joined the R&D organization of SGS Microelettronica, a predecessor company to ST, in 1984. He was promoted to R&D Director of Operations in 1989 and became Automotive Business Unit Director in 1996. After two years in the US as President and CEO of Semitool, a semiconductor manufacturing equipment vendor, he rejoined ST in 2000 as Group VP responsible for the RAM/PSRAM Product Division and the Flash Automotive Business Unit. In 2005, Gualandris was appointed CEO of ST Incard, an ST smart-card subsidiary. In 2008-2010, he served as VP and Supply Chain General Manager at ST's memory joint venture with Intel. In 2011, Gualandris was appointed ST's Executive Vice President in charge of Product Quality Excellence.

Gualandris has authored several technical and managerial papers and holds some international patents. He serves as Chairman of STS, ST's manufacturing joint venture in China, and previously sat on boards at Incard, Numonyx, and the Numonyx-Hynix joint venture.

Fabio Gualandris was born in Bergamo, Italy, in 1959. He graduated in Physics from the University of Milan.

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